Unit: mm

TOSHIBA Schottky Barrier Rectifier Schottky Barrier Type

CMS03

Switching Mode Power Supply Applications Portable Equipment Battery Applications

 $\begin{array}{ll} \bullet & \text{Repetitive peak reverse voltage} & \vdots \text{$V_{RRM} = 30$ V} \\ \bullet & \text{Average forward current} & \vdots \text{I_{F} (AV)} = 3$ A} \\ \bullet & \text{Peak forward voltage} & \vdots \text{$V_{FM} = 0.45$ V (max)} \\ \end{array}$

Suitable for compact assembly due to small surface-mount package

"M-FLATTM" (Toshiba package name)

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | Symbol | Rating | Unit |
|---|------------------|------------|------|
| Repetitive peak reverse voltage | VRRM | 30 | V |
| Average forward current | IF (AV) | 3 (Note 1) | Α |
| Non-repetitive peak forward surge current | IFSM | 40 (50 Hz) | Α |
| Junction temperature | Tj | -40 to 150 | °C |
| Storage temperature | T _{stg} | -40 to 150 | °C |

Note 1: $T\ell = 117.6$ °C Rectangular waveform ($\alpha = 180$ °), VR = 15 V

Ta = 28.4°C Device mounted on a ceramic board

 $\begin{array}{lll} \text{Board size} & : 50 \text{ mm} \times 50 \text{ mm} \\ \text{Soldering land size} & : 2 \text{ mm} \times 2 \text{ mm} \\ \text{Board thickness} & : 0.64 \text{ mm} \end{array}$

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in

JEDEC —

JEITA —

TOSHIBA 3-4E1A

Weight: 0.023 g (typ.)

temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

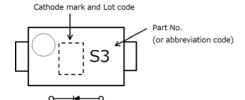
Electrical Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|-----------|---|-----|--------|------|------|
| | VFM (1) | IFM = 0.5 A (pulse test) | _ | 0.35 — | | |
| Peak forward voltage | VFM (2) | I _{FM} = 1 A (pulse test) | _ | 0.37 | _ | ٧ |
| | VFM (3) | IFM = 3 A (pulse test) | _ | 0.42 | 0.45 | |
| IRRM (1) VRRM = 5 V (pulse test) | | _ | 3 | _ | | |
| Repetitive peak reverse current | IRRM (2) | V _{RRM} = 30 V (pulse test) | _ | 30 | 500 | μΑ |
| Junction capacitance | Cj | V _R = 10 V, f = 1 MHz | _ | 190 | _ | pF |
| Thermal resistance(junction to ambient) Rth (j- | D | Device mounted on a ceramic board board size : 50 mm × 50 mm soldering land size : 2 mm × 2 mm board thickness : 0.64 mm | _ | _ | 60 | |
| | Rth (j-a) | Device mounted on a glass-epoxy board board size : 50 mm × 50 mm soldering land size : 6 mm × 6 mm board thickness : 1.6 mm | _ | _ | 135 | °C/W |
| Thermal resistance (junction to lead) | Rth (j-l) | _ | _ | _ | 16 | |

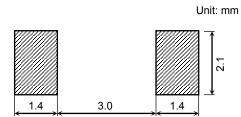
Start of commercial production 2000-07

Marking

| Abbreviation Code | Part No. | | |
|-------------------|----------|--|--|
| S3 | CMS03 | | |

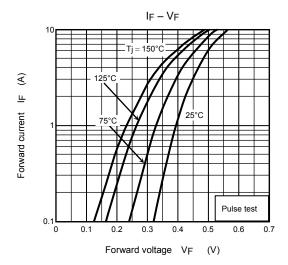


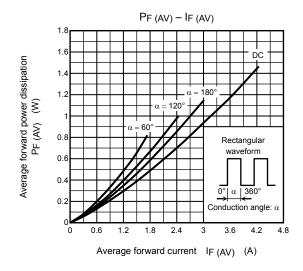
Land pattern dimensions for reference only

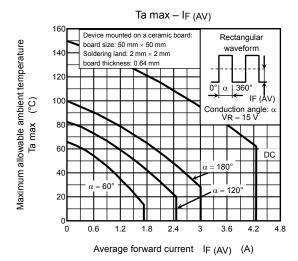


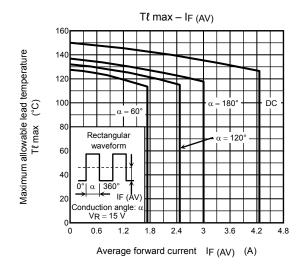
Handling Precaution

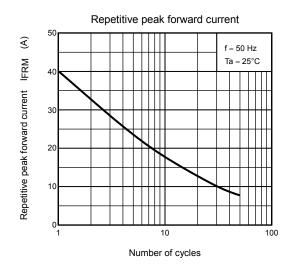
- 1) Schottky barrier diodes (SBDs) have reverse current greater than other types of diodes. This makes SBDs more vulnerable to damage due to thermal runaway under high-temperature and high-voltage conditions. Thus, both forward and reverse power losses of SBDs should be considered for thermal and safety design.
- 2) The absolute maximum ratings are rated values that must not be exceeded during operation, even for an instant. The following are the recommended general derating methods for designing a circuit board using this device.
 - V_{RRM}: Use this rating with reference to 1) above. V_{RRM} has a temperature coefficient of 0.1%/°C at low temperatures. Take this coefficient into account when designing a circuit board that will be operated in a low-temperature environment.
 - $I_{F(AV)}$: We recommend that the worst-case current be no greater than 80% of the absolute maximum rating of $I_{F(AV)}$ and that the worst-case junction temperature, T_j , be kept below 120°C. When using this device, allow margins, referring to the $T_{a(max)}$ - $I_{F(AV)}$ curve.
 - I_{FSM}: This rating specifies peak non-repetitive forward surge current. This only applies to an abnormal operation, which seldom occurs during the lifespan of a device.
 - T_j: Derate device parameters in proportion to this rating in order to ensure high reliability. We recommend that the junction temperature (T_j) of a device be kept below 120°C.
- 3) Thermal resistance (junction-to-ambient) varies with the mounting conditions of a device on a circuit board. An appropriate thermal resistance value should be used, considering the heatsink, circuit board design and land pattern dimensions (provided for reference only).
- 4) For other design considerations, see the Rectifiers databook or the Toshiba website.

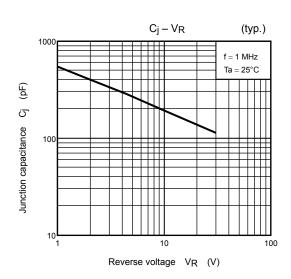


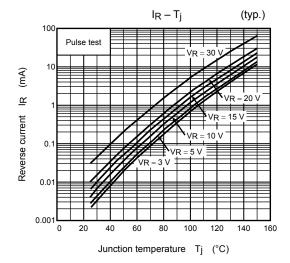


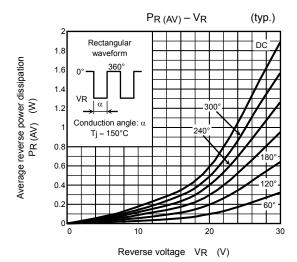


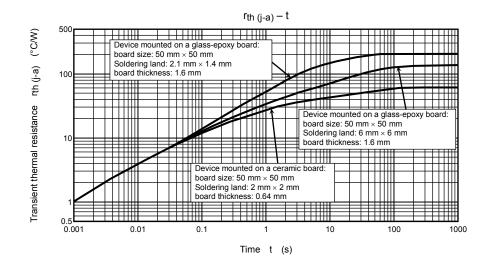












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